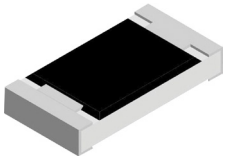


## Description:



The resistors are constructed in a high grade ceramic body (aluminium oxide). Internal metal electrodes are added at each end and connected by a resistive paste that is applied to the top surface of the substrate. The composition of the paste is adjusted to give the approximate resistance required and the value is trimmed to within tolerance by laser cutting of this resistive layer.

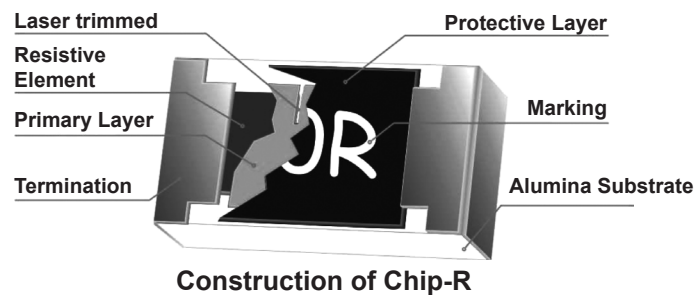
The resistive layer is covered with a protective coat. Finally, the two external end terminations are added. For ease of soldering the outer layer of these end terminations is a Tin (lead free) alloy.

## Features:

- High power rating and compact size
- High reliability and stability
- Reduced size of final equipment
- Flame Retardant

## Application:

- Power supply
- PDA, Digital meter
- Computer, Battery charger and Automotive industry
- DC-DC power converter



## Quick Reference Data

Item	General Specification
Series No.	MCWF12P
Size code	1206 (3216)
Resistance Tolerance	±1%, ±5%
Resistance Range	0Ω, 1Ω~ 1MΩ
TCR (ppm/°C)	±100
Max. Dissipation @ Tamb = 70°C	1/2 W
Max. Operation Voltage (DC or RMS)	200V
Max. Overload Voltage (DC or RMS)	400V
Climatic category (IEC 60068)	55/155/56

### Note:

1. This is the maximum voltage that may be continuously supplied to the resistor element, see "IEC publication 60115-8"
2. Max. Operation Voltage : So called RCWV (Rated Continuous Working Voltage) is determined by  

$$RCWV = \sqrt{\text{Rated Power} \times \text{Resistance Value}}$$
 or Max. RCWV listed above, whichever is lower.
3. 2W loading with total solder-pad and trace size of 300 mm<sup>2</sup>
4. 0Ω maximum resistance  $R_{max} \leq 20m\Omega$

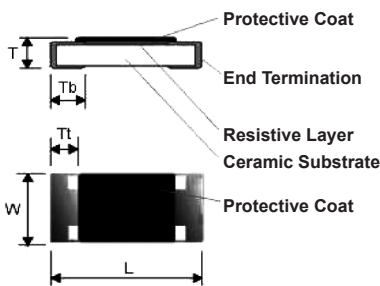
# Thick Film High Power Chip Resistor



## Test Condition for Jumper (0Ω)

Item	MCWF12P
Power Rating At 70°C	1/2W
Resistance	Max. 20mΩ
Rated Current	5A
Peak Current	12.5A
Operating Temperature	-55°C to +155°C

## Mechanical Data



Part Number	MCWF12P
L	3.1 ±0.15
W	1.6 ±0.15
T	0.55 ±0.1
Tb	0.5 ±0.25
Tt	0.5 ±0.25

Dimensions : Millimetres

## Marking

Each resistor is marked with a four-digit (MCWF12P ±1%) and three-digit (MCWF12P ±5%) code on the protective coating to designate the nominal resistance value.

### Example:

102 = 1kΩ                      16R0 = 16Ω

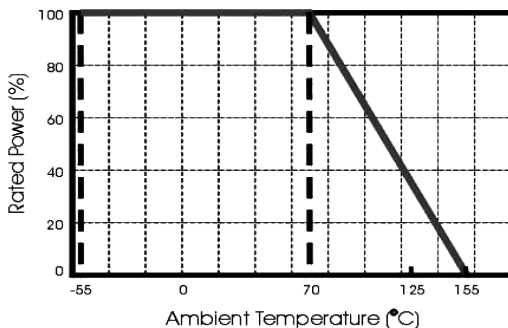
## Functional Description:

### Product characterization

Standard values of nominal resistance are taken from the E96 & E24 series for resistors with a tolerance of ±5% & ±1%. The values of the E24/E96 series are in accordance with "IEC publication 60063".

### Derating

The power that the resistor can dissipate depends on the operating temperature.



**Max. Dissipation in percentage of rated power  
As a function of the ambient temperature**



## Mounting

Due to their rectangular shapes and small tolerances, Surface Mountable Resistors are suitable for handling by automatic placement systems.

Chip placement can be on ceramic substrates and printed-circuit boards (PCBs).

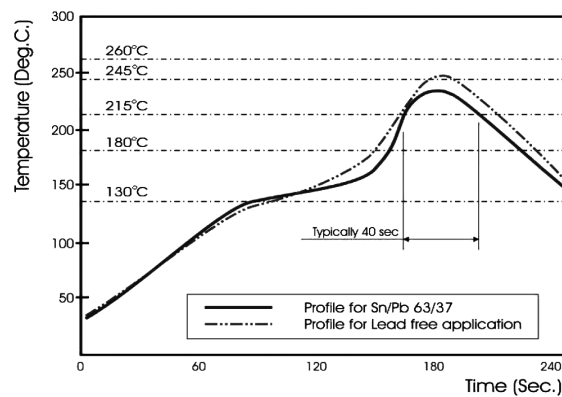
Electrical connection to the circuit is by individual soldering condition.

The end terminations guarantee a reliable contact.

## Soldering Condition:

The robust construction of chip resistors allows them to be completely immersed in a solder bath of 260°C for 10 seconds. Therefore, it is possible to mount Surface Mount Resistors on one side of a PCB and other discrete components on the reverse (mixed PCBs).

Surface Mount Resistors are tested for solderability at 235°C during 2 seconds. The test condition for no leaching is 260°C for 30 seconds. Typical examples of soldering processes that provide reliable joints without any damage are given in below figure.



Infrared soldering profile for Chip Resistors

## Catalogue Numbers:

The resistors have a catalogue number starting with

MCWFFX	P	1000	F	T	L
<b>Size code</b> MCWF12 : 1206	<b>Type code</b> P : Power 1206 size = 0.5 Watt	<b>Resistance code</b> 5% E24 : 2 significant digits followed by No. of zeros e.g.: 3Ω =3R0 10Ω =100 56kΩ =563 1% E24+E96: 3 significant digits followed by No. of zeros 100Ω = 1000 37.4kΩ = 3742	<b>Tolerance</b> J : ±5% F : ±1% P : Jumper	<b>Packaging code</b> T : 7" Reeled taping	<b>Termination code</b> L = Sn base (lead free)

Tape packaging MCWF12 : 8mm width paper taping 5,000pcs per reel.

## Test And Requirements

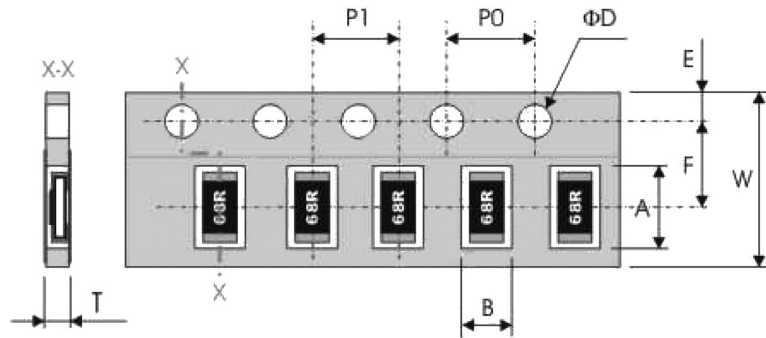
Basic specification : JIS C 5201-1 : 1998

Test	Procedure	Requirement
<b>Clause 4.8</b> Temperature Coefficient of Resistance (TCR )	Natural resistance change per change in degree Centigrade. $\frac{R_2 - R_1}{R_1(t_2 - t_1)} \times 10^6 \quad (\text{ppm}/^\circ\text{C})$ R <sub>1</sub> : Resistance at reference temperature R <sub>2</sub> : Resistance at test temperature t <sub>1</sub> : 20°C +5°C -1°C.	Refer to quick reference data for T.C.R specification
<b>Clause 4.13</b> Short time overload	5 × Rated power or Max. Overload Voltage for 5 sec. Measure resistance after 30 minutes.	ΔR/R max. J : ≤±(2% +0.1Ω) F : ≤±(1% +0.05Ω)
<b>Clause 4.18</b> Resistance to soldering heat (R.S.H)	Un-mounted chips completely immersed for 10±1second in a SAC solder bath at 260°C ±5°C.	No visible damage ΔR/R max. J : ≤±(1% +0.1Ω) F : ≤±(0.5% +0.05Ω)
<b>Clause 4.17</b> Solderability	Un-mounted chips completely immersed for 2 ±0.5 second in a SAC solder bath at 235°C ±5°C.	Good tinning (>95% covered) No visible damage
<b>Clause 4.18</b> Leach Test	Un-mounted chips completely immersed for 60±1second in a solder bath at 260°C ±5°C	Ditto
<b>Clause 4.19</b> Temperature cycling	1. 30 minutes at -55°C ±3°C, 2. 2~3 minutes at 20°C +5°C-1°C, 3. 30 minutes at +155° ±3°C, 4. 2~3 minutes at 20°C +5°C-1°C, Total 5 continuous cycles.	No visible damage ΔR/R max. J ≤±(1%+0.1Ω) F ≤±(0.5%+0.05Ω)
<b>Clause 4.25</b> Load life (endurance)	1000 +48/-0 hours, loaded with RCWV or Vmax in chamber controller 70±2°C, 1.5 hours on and 0.5 hours off.	No visible damage ΔR/R max. J ≤±(3%+0.1Ω) F ≤±(1%+0.05Ω)
<b>Clause 4.24</b> Load life in Humidity	1000 +48/-0 hours, loaded with RCWV or Vmax in humidity chamber controller at 40°C±2°C and 90~95% relative humidity, 1.5 hours on and 0.5 hours off.	No visible damage ΔR/R max. J ≤±(3%+0.1Ω) F ≤±(1%+0.05Ω)
<b>Clause 4.33</b> Bending strength	Resistors mounted on a 90mm glass epoxy resin PCB(FR4); bending : 3mm, once for 10 seconds.	No visible damage ΔR/R max. J ≤±(1%+0.1Ω) F ≤±(0.5%+0.05Ω)
<b>Clause 4.32</b> Adhesion	Pressurizing force: 5N, Test time: 10±1sec.	No remarkable damage or removal of the terminations
<b>Clause 4.6</b> Insulation Resistance	Apply the maximum overload voltage (DC) for 1 minute.	R ≥ 10GΩ
<b>Clause 4.7</b> Dielectric Withstand Voltage	Apply the maximum overload voltage (AC) for 1 minute.	No breakdown or flashover

# Thick Film High Power Chip Resistor

## Packaging:

### Paper Tape specifications

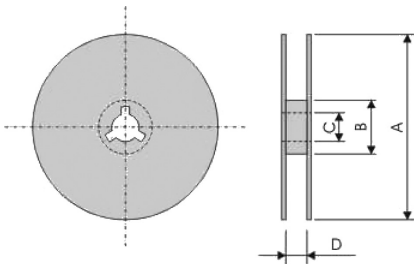


Series No.	A	B	W	F	E
MCWF12P	3.6 ±0.2	2 ±0.2	8 ±0.3	3.5 ±0.2	1.75 ±0.1

Series No.	P1	P0	D	T
MCWF12P	4 ±0.1	4 ±0.1	1.5 <sup>+0.1</sup> <sub>-0</sub>	Max. 1

Dimensions : Millimetres

### Reel dimensions:



Reel / Tape	A	B	C	D
7" reel for 8mm tape	Φ178 ±2	Φ60 ±1	13 ±0.2	9 ±0.5

Dimensions : Millimetres

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